

Features

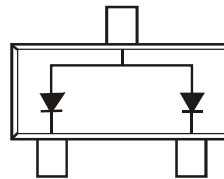
- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- Two Diode Elements Connected in a Common Anode Configuration
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 ③
- Polarity: See Diagram
- Weight: 0.008 grams (approximate)



Top View

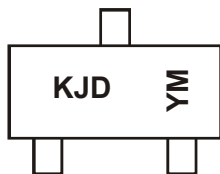

 Top View
Internal Schematic

Ordering Information (Note 4)

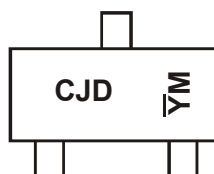
| Part Number | Compliance | Case | Packaging |
|-------------|------------|-------|--------------------|
| BAW56-7-F | Standard | SOT23 | 3,000/Tape & Reel |
| BAW56-13-F | Standard | SOT23 | 10,000/Tape & Reel |
| BAW56Q-7-F | Automotive | SOT23 | 3,000/Tape & Reel |
| BAW56Q-13-F | Automotive | SOT23 | 10,000/Tape & Reel |

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



K = SAT (Shanghai Assembly / Test site)
 JD = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: A = 2013)
 M = Month (ex: 9 = September)



C = CAT (Chengdu Assembly / Test site)
 JD = Product Type Marking Code
 YM = Date Code Marking for Chengdu
 Y = Year (ex: A = 2013)
 M = Month (ex: 9 = September)

Date Code Key

| Year | 1998 | 1999 | 2000 | | 2007 | 2008 | 2009 | 2010 | 2011 | 2012 | 2013 | 2014 | 2015 | 2016 | 2017 |
|------|------|------|------|-------|------|------|------|------|------|------|------|------|------|------|------|
| Code | J | K | L | | U | V | W | X | Y | Z | A | B | C | D | E |

| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | O | N | D |

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | |
|---|--------------|------------------------|------|---|
| Non-Repetitive Peak Reverse Voltage | V_{RM} | 100 | V | |
| Peak Repetitive Reverse Voltage | V_{RRM} | 75 | V | |
| Working Peak Reverse Voltage | V_{RWM} | | | |
| DC Blocking Voltage | V_R | | | |
| RMS Reverse Voltage | $V_{R(RMS)}$ | 53 | V | |
| Forward Continuous Current (Note 5) | I_{FM} | 300 | mA | |
| Non-Repetitive Peak Forward Surge Current | I_{FSM} | @ $t = 1.0\mu\text{s}$ | 2.0 | A |
| | | @ $t = 1.0\text{s}$ | 1.0 | |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|-----------------|-------------|--------------------|
| Power Dissipation (Note 5) | P_D | 350 | mW |
| Thermal Resistance Junction to Ambient Air (Note 5) | $R_{\theta JA}$ | 357 | $^\circ\text{C/W}$ |
| Operating and Storage Temperature Range | T_J, T_{STG} | -65 to +150 | $^\circ\text{C}$ |

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

| Characteristic | Symbol | Min | Max | Unit | Test Condition |
|------------------------------------|-------------|-----|-------------------------------|---|--|
| Reverse Breakdown Voltage (Note 6) | $V_{(BR)R}$ | 75 | — | V | $I_R = 2.5\mu\text{A}$ |
| Forward Voltage | V_F | — | 0.715 0.855 1.0 1.25 | V | $I_F = 1.0\text{mA}$ $I_F = 10\text{mA}$ $I_F = 50\text{mA}$ $I_F = 150\text{mA}$ |
| Reverse Current (Note 6) | I_R | — | 2.5 50 30 25 | μA μA μA nA | $V_R = 75\text{V}$ $V_R = 75\text{V}, T_J = +150^\circ\text{C}$ $V_R = 25\text{V}, T_J = +150^\circ\text{C}$ $V_R = 20\text{V}$ |
| Total Capacitance | C_T | — | 2.0 | pF | $V_R = 0, f = 1.0\text{MHz}$ |
| Reverse Recovery Time | t_{rr} | — | 4.0 | ns | $I_F = I_R = 10\text{mA}$, $I_{rr} = 0.1 \times I_R, R_L = 100\Omega$ |

Notes: 5. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com>.
6. Short duration pulse test used to minimize self-heating effect.

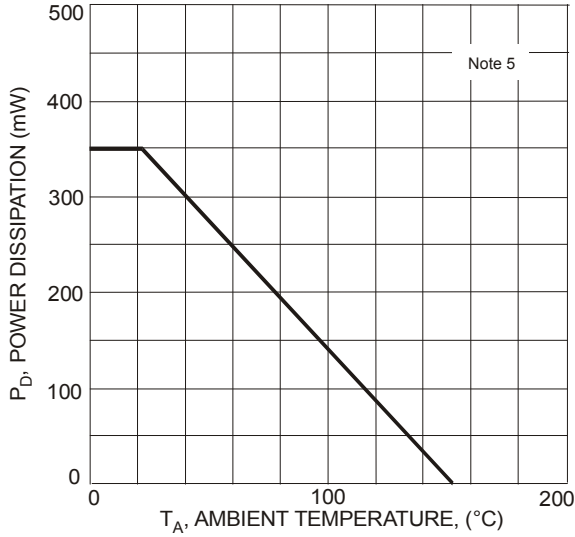


Fig. 1 Power Derating Curve, Total Package

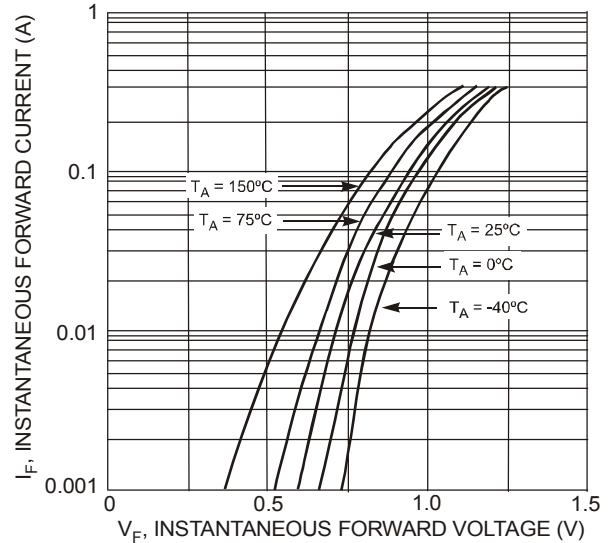


Fig. 2 Typical Forward Characteristics, Per Element

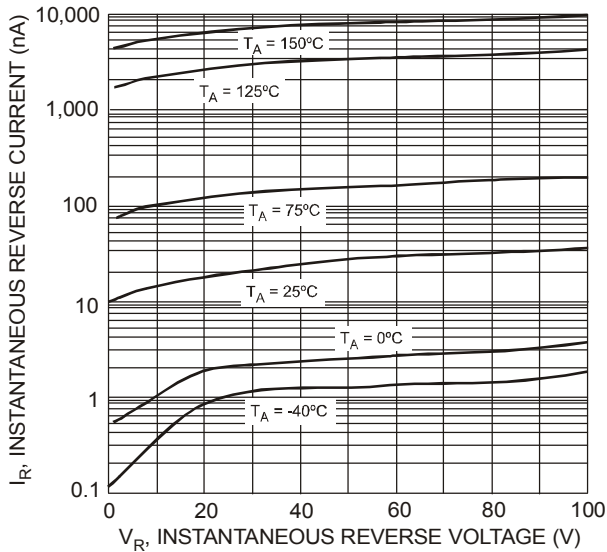


Fig. 3 Typical Reverse Characteristics, Per Element

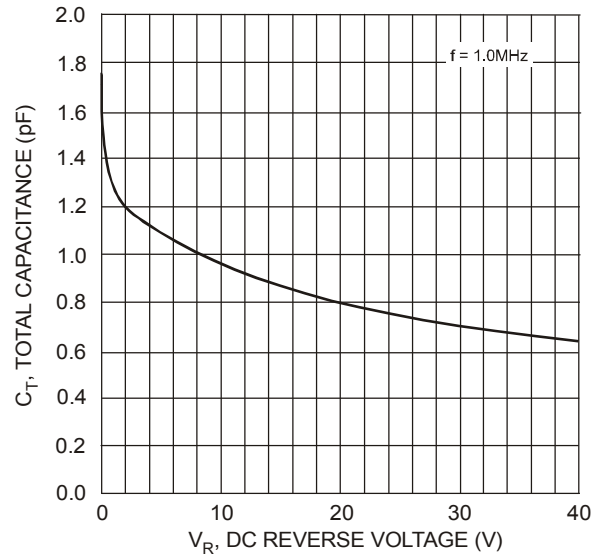
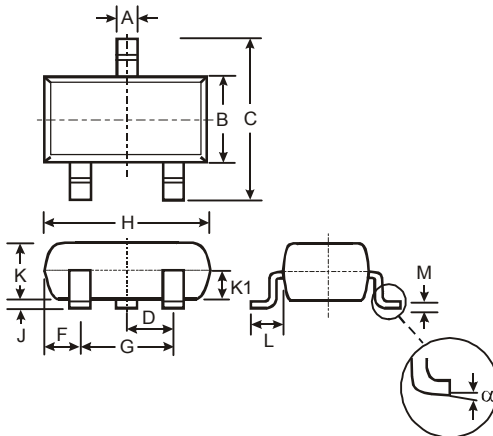


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

Package Outline Dimensions

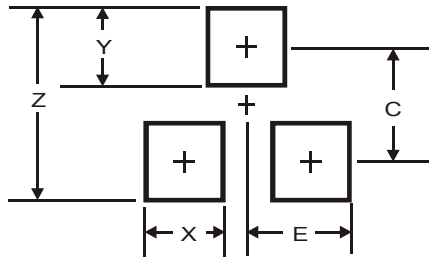
Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



| SOT23 | | | |
|----------------------|-------|------|-------|
| Dim | Min | Max | Typ |
| A | 0.37 | 0.51 | 0.40 |
| B | 1.20 | 1.40 | 1.30 |
| C | 2.30 | 2.50 | 2.40 |
| D | 0.89 | 1.03 | 0.915 |
| F | 0.45 | 0.60 | 0.535 |
| G | 1.78 | 2.05 | 1.83 |
| H | 2.80 | 3.00 | 2.90 |
| J | 0.013 | 0.10 | 0.05 |
| K | 0.903 | 1.10 | 1.00 |
| K1 | - | - | 0.400 |
| L | 0.45 | 0.61 | 0.55 |
| M | 0.085 | 0.18 | 0.11 |
| α | 0° | 8° | - |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.9 |
| X | 0.8 |
| Y | 0.9 |
| C | 2.0 |
| E | 1.35 |

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